



7N65K

Preliminary

Power MOSFET

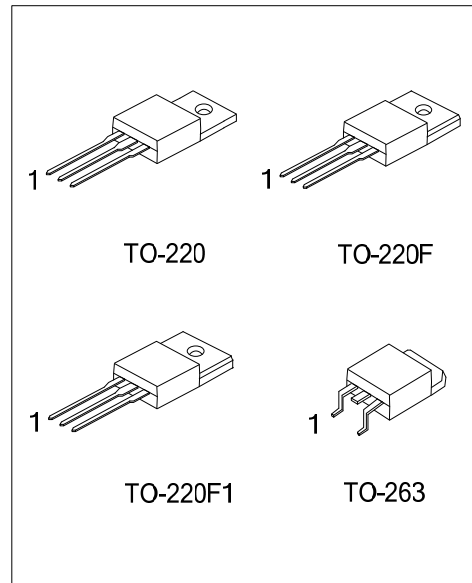
**7.4A, 650V N-CHANNEL
POWER MOSFET**

■ DESCRIPTION

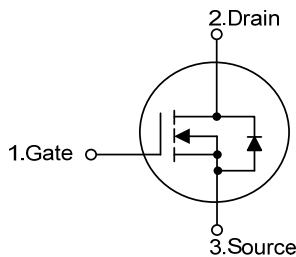
The UTC **7N65K** is a high voltage power MOSFET and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and have a high rugged avalanche characteristics. This power MOSFET is usually used at high speed switching applications in switching power supplies and adaptors.

■ FEATURES

- * $R_{DS(ON)} < 1.4\Omega @ V_{GS} = 10V$
- * Ultra low gate charge (typical 29 nC)
- * Low reverse transfer Capacitance ($C_{RSS} =$ typical 16pF)
- * Fast switching capability
- * Avalanche energy tested
- * Improved dv/dt capability, high ruggedness



■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
7N65KL-TA3-T 7N65	KG-TA3-T	TO-220	G	D	S	Tube
7N65KL-TF3-T 7N65	KG-TF3-T	TO-220F	G	D	S	Tube
7N65KL-TF1-T 7N65	KG-TF1-T	TO-220F1	G	D	S	Tube
7N65KL-TQ2-T 7N65	KG-TQ2-T	TO-263	G	D	S	Tube
7N65KL-TQ2-R 7N65	KG-TQ2-R	TO-263	G	D	S	Tape Reel

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>7N65KL-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Lead Free</p>	<p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220 ,TF3: TO-220F, TF1: TO-220F1, TQ2: TO-263</p> <p>(3) L: Lead Free, G: Halogen Free</p>
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■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER SYMBOL			RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	650	V	
Gate-Source Voltage		V_{GSS}	± 30	V	
Avalanche Current (Note 2)		I_{AR}	7.4	A	
Drain Current	Continuous I	I_D	7.4	A	
	Pulsed (Note 2)	I_{DM}	29.6	A	
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	200	mJ	
	Repetitive (Note 2)	E_{AR}	14.2	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
Power Dissipation	TO-220	P_D	142 W		
	TO-220F/TO-220F1 48			W	
	TO-263 50			W	
Junction Temperature		T_J	+	150	$^\circ\text{C}$
Storage Temperature		T_{STG}		-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature

3. $L = 8.16\text{mH}$, $I_{AS} = 7\text{A}$, $V_{DD} = 50\text{V}$, $R_G = 25\ \Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD} \leq 7.4\text{A}$, $di/dt \leq 200\text{A}/\mu\text{s}$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

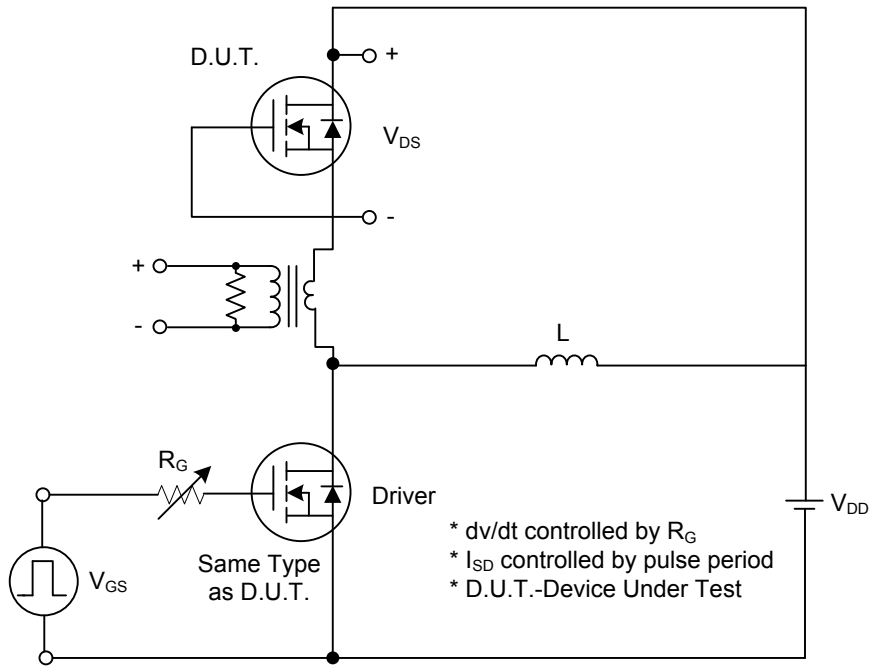
PARAMETER SYMBOL			RATINGS	UNIT
Junction to Ambient		θ_{JA}	62.5	$^\circ\text{C}/\text{W}$
Junction to Case	TO-220	θ_{JC}	0.88 $^\circ\text{C}/\text{W}$	
	TO-220F/TO-220F1 2.6			$^\circ\text{C}/\text{W}$
	TO-263		2.5	$^\circ\text{C}/\text{W}$

■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

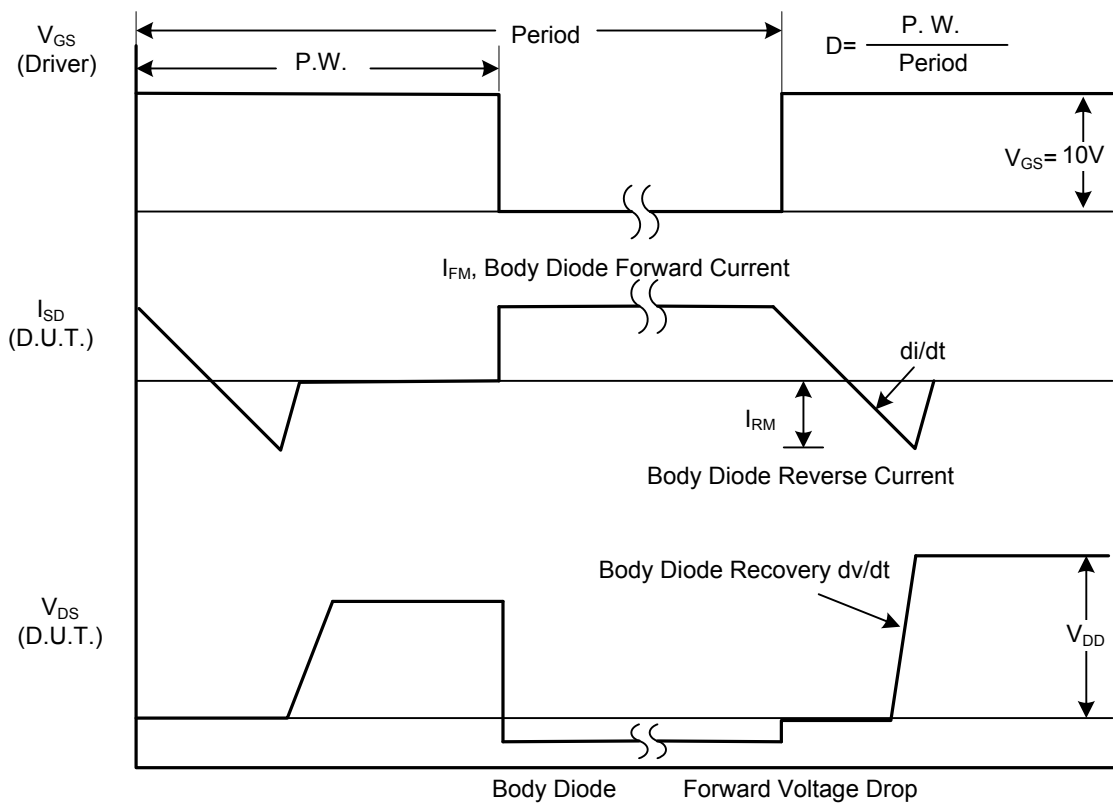
PARAMETER SYMBOL		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	V _{GS} = 0V, I _D = 250μA	650		V	
Drain-Source Leakage Current		I _{DSS}	V _{DS} = 650V, V _{GS} = 0V		1	μA	
Gate- Source Leakage Current	Forward	I _{GSS}	V _{GS} = 30V, V _{DS} = 0V		100	nA	
	Reverse		V _{GS} = -30V, V _{DS} = 0V		-100	nA	
Breakdown Voltage Temperature Coefficient		ΔBV _{DSS} /ΔT _J	I _D =250μA, Referenced to 25°C	0.67		V/°C	
ON CHARACTERISTICS							
Gate Threshold Voltage		V _{GS(TH)}	V _{DS} = V _{GS} , I _D = 250μA	2.5	4.5	V	
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} = 10V, I _D = 3.7A	1.1	1.4	Ω	
DYNAMIC CHARACTERISTICS							
Input Capacitance		C _{ISS}	V _{DS} =25V, V _{GS} =0V, f=1.0 MHz		1400	pF	
Output Capacitance		C _{OSS}			180	pF	
Reverse Transfer Capacitance		C _{RSS}			16	21	pF
SWITCHING CHARACTERISTICS							
Turn-On Delay Time		t _{D(ON)}	V _{DD} =325V, I _D =7.4A R _G =25Ω (Note 1, 2)		70	ns	
Turn-On Rise Time		t _R			80	170	ns
Turn-Off Delay Time		t _{D(OFF)}				140	ns
Turn-Off Fall Time		t _F			50	130	ns
SWITCHING CHARACTERISTICS							
Total Gate Charge		Q _G	V _{DS} =520V, I _D =7.4A V _{GS} =10 V (Note 1, 2)		29	38	nC
Gate-Source Charge		Q _{GS}			7		nC
Gate-Drain Charge		Q _{GD}			14.5		nC
DRAIN-SOURCE DIODE CHARACTERISTICS AND MAXIMUM RATINGS							
Drain-Source Diode Forward Voltage		V _{SD}	V _{GS} = 0V, I _S = 7.4 A		1.4	V	
Maximum Continuous Drain-Source Diode Forward Current		I _S			7.4	A	
Maximum Pulsed Drain-Source Diode Forward Current		I _{SM}			29.6	A	
Reverse Recovery Time		t _{rr}	V _{GS} = 0V, I _S = 7.4 A		320	ns	
Reverse Recovery Charge		Q _{RR}	dI _F / dt = 100A/μs (Note 1)	2.4		μC	

- Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

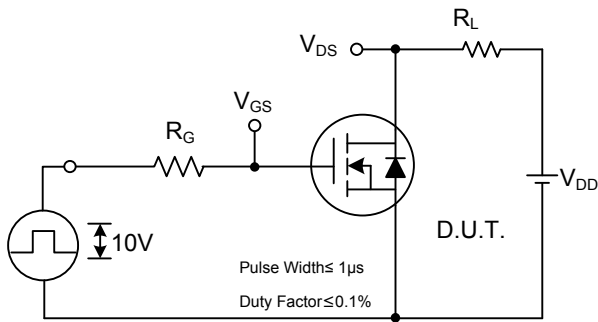


Peak Diode Recovery dv/dt Test Circuit

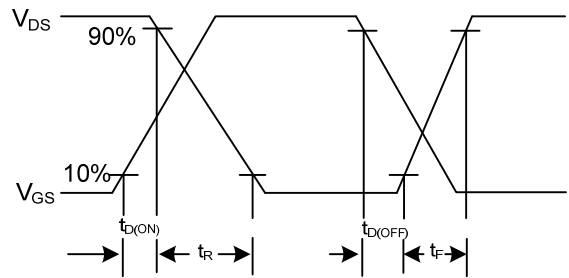


Peak Diode Recovery dv/dt Waveforms

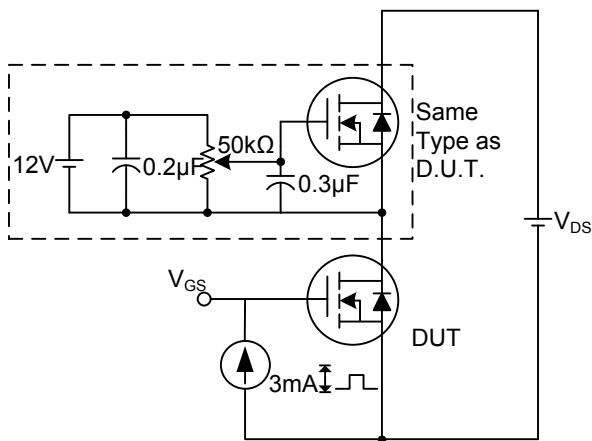
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



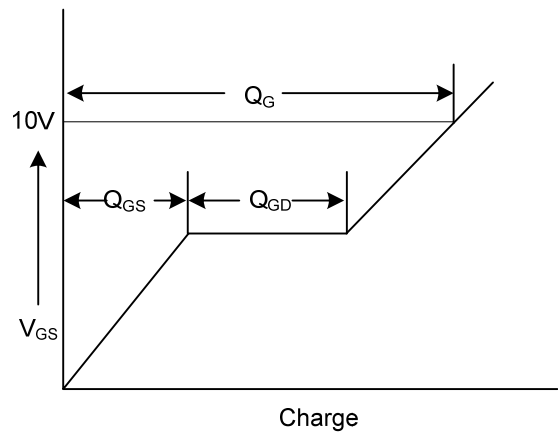
Switching Test Circuit



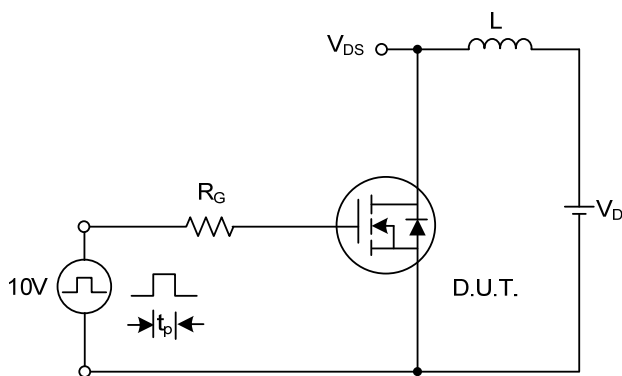
Switching Waveforms



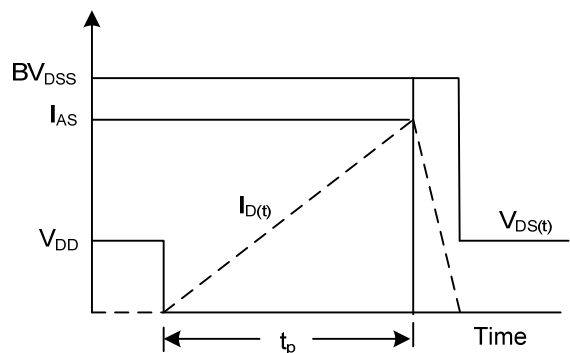
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms

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